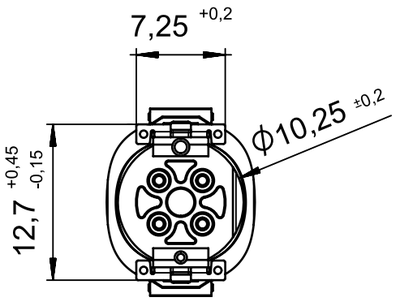
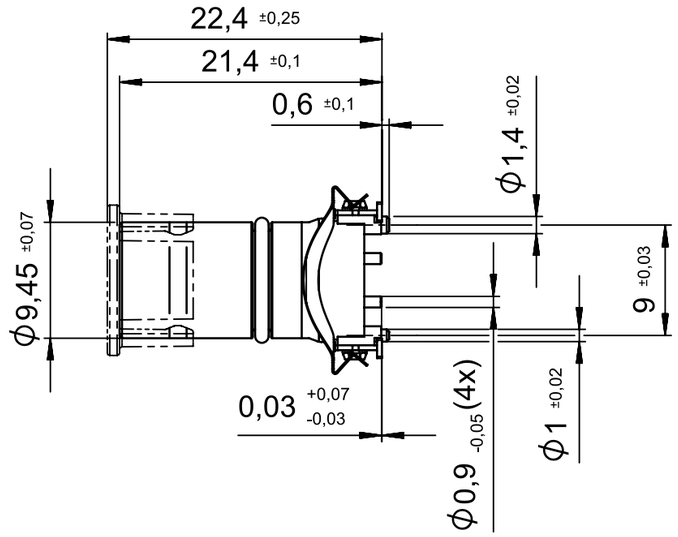
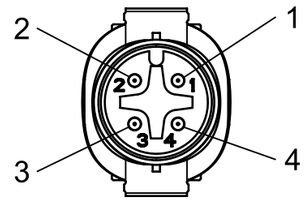
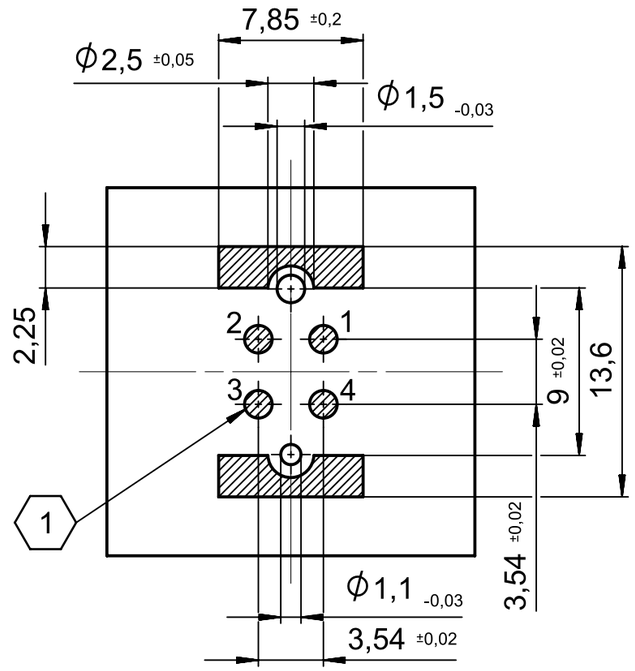



plug face male




## PCB-layout (advice)




3:1

Coplanarity of all contacts and anchor plate | 0.1

Recommended solder paste thickness 150µm

(1) Further information on soldering process and recommended layout, see brochure "Connectors for SMT production"

- EN ISO 291 23/50

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|---|---|---|---|
| DIN A3 | document-no. / ri: 102981897 / 00 | article-no. / ri: 1411955 / 06 | scale: 2:1 |
| PHOENIX CONTACT | date: 2025-10-29 | document-type: TECDOC 2D-Productdrawing | - Simplified representation<br>- Linear dimensions (mm) |
| | description: SACC-CIP-M12MS-4P SMD SH T | | |
| | page 1 of 1 | | |

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